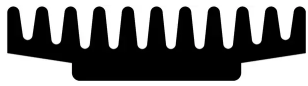


Data sheet Product ICK SMD C 17 MI



Heatsinks and active heatsinks for processors>Heatsinks for DIL-IC, PLCC and SMD

30 x 7,5 mm, for SMD components and others

Features

width:	30 mm
height:	7.5 mm
plate thickness:	2.8 mm
length:	17 mm
thermal resistance:	17 K/W
surface:	solderable surface

Technical Drawing

